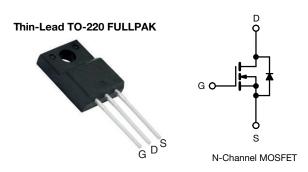
Vishay Siliconix

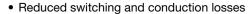
## **E Series Power MOSFET**



PRODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	85	50	
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.82		
Q <sub>g</sub> max. (nC)	4	4	
Q <sub>gs</sub> (nC)	5	5	
Q <sub>gd</sub> (nC)	8	3	
Configuration	Sin	gle	

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA6N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	800	V
Gate-source voltage			$V_{GS}$	± 30	V
Continuous drain current (T,I = 150 °C) e	V -+ 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	,	5.4	
Continuous drain current (1) = 150 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	l <sub>D</sub>	3.4	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	15	
Linear derating factor				0.25	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	95	mJ
Maximum power dissipation			$P_{D}$	31	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C		70		V/ns
Reverse diode dv/dt d			dv/dt	0.25	V/IIS
Soldering recommendations (peak temperature) <sup>c</sup>	For	10 s		300	°C
Mounting torque	M3 s	screw		0.6	Nm

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 2.6 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C
- e. Limited by maximum junction temperature



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	4.0	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	1.1	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana alian alian adalah an anal		V <sub>DS</sub> =	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3 A	-	0.82	0.94	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	s = 30 V, I <sub>D</sub> = 3 A	-	2.5	-	S
Dynamic		•		•	•	•	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	827	-	pF
Output capacitance	C <sub>oss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		37	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V 0V 400V V 0V		-	24	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 \	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		109	-	
Total gate charge	Qg			-	22	44	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A, V_{DS} = 480 V$	-	5	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	8	-	
Turn-on delay time	t <sub>d(on)</sub>			-	13	26	
Rise time	t <sub>r</sub>	Van	$V_{DD} = 480 \text{ V}, I_D = 3 \text{ A},$		9	18	
Turn-off delay time	t <sub>d(off)</sub>		= 10 V, $R_q = 9.1 \Omega$	-	27	54	ns
Fall time	t <sub>f</sub>		Ů	-	18	36	1
Gate input resistance	$R_g$	f = 1	f = 1 MHz, open drain		1.0	2.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	5.4	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	15	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$ $di/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	282	564	ns
Reverse recovery charge	Q <sub>rr</sub>			_	2.0	4.0	μC
Reverse recovery current	I <sub>RRM</sub>			_	11	-	Α

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

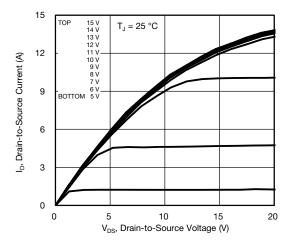


Fig. 1 - Typical Output Characteristics

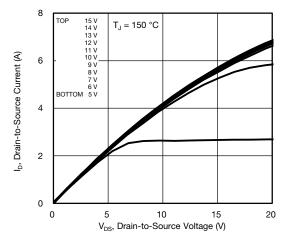


Fig. 2 - Typical Output Characteristics

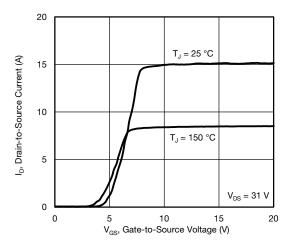


Fig. 3 - Typical Transfer Characteristics

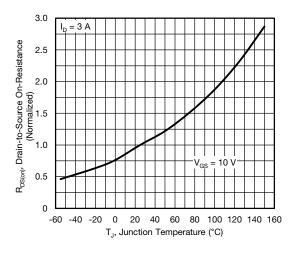


Fig. 4 - Normalized On-Resistance vs. Temperature

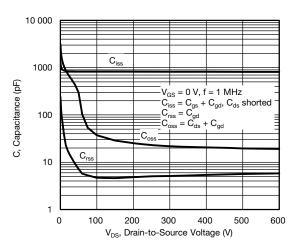


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

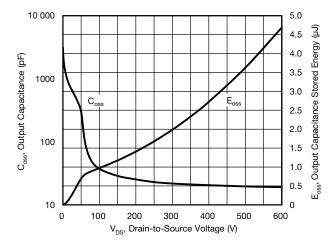


Fig. 6 -  $C_{oss}$  and  $E_{oss}\, vs.\, V_{DS}$ 



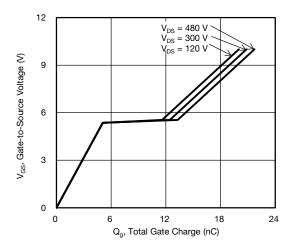


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

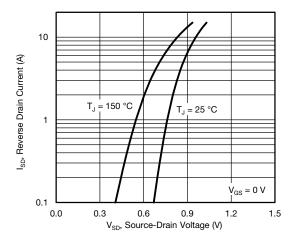


Fig. 8 - Typical Source-Drain Diode Forward Voltage

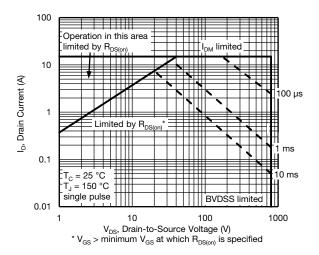


Fig. 9 - Maximum Safe Operating Area

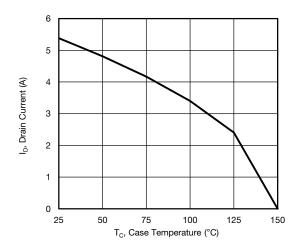


Fig. 10 - Maximum Drain Current vs. Case Temperature

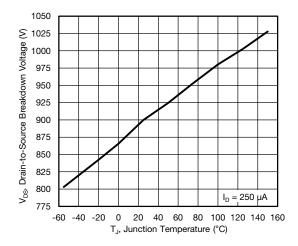


Fig. 11 - Temperature vs. Drain-to-Source Voltage



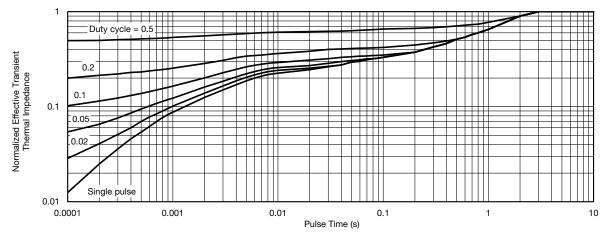


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

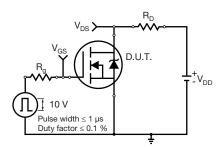


Fig. 13 - Switching Time Test Circuit

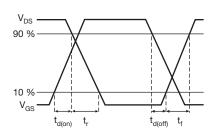


Fig. 14 - Switching Time Waveforms

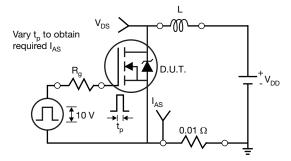


Fig. 15 - Unclamped Inductive Test Circuit

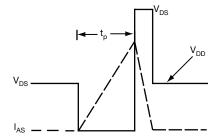


Fig. 16 - Unclamped Inductive Waveforms

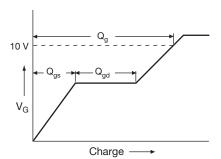


Fig. 17 - Basic Gate Charge Waveform

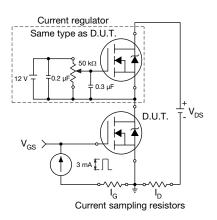
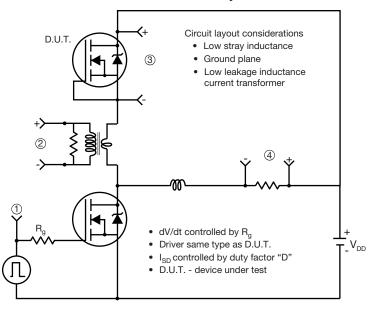


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



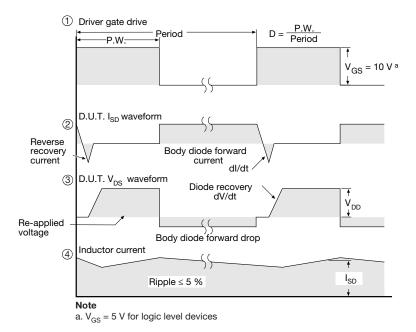


Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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